CMOS Digital Integrated Circuits Silicon Monolithic

74LCX74FT

1. Functional Description

• Low-Voltage Dual D-Type Flip-Flop with 5-V Tolerant Inputs and Outputs

2. General

The 74LCX74FT is a high-performance CMOS D-type flip-flop. Designed for use in 3.3 V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage $(3.3\ V)\ V_{CC}$ applications, but it could be used to interface to 5 V supply environment for inputs.

The signal level applied to the D input is transferred to Q output during the positive going transition of the CK pulse.

 $\overline{\text{CLR}}$ and $\overline{\text{PR}}$ are independent of the CK and are accomplished by setting the appropriate input low.

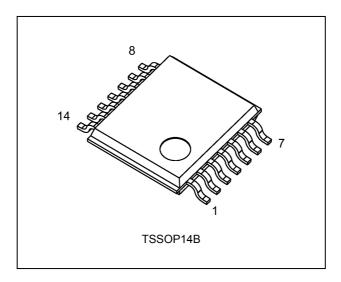
All inputs are equipped with protection circuits against static discharge.

3. Features

- (1) AEC-Q100 (Rev. H) (Note 1)
- (2) Wide operating temperature range: $T_{opr} = -40$ to 125 °C
- (3) Low-voltage operation: $V_{CC} = 1.65$ to 3.6 V
- (4) High-speed operation: $t_{pd} = 8.0 \text{ ns (max)} (V_{CC} = 3.3 \pm 0.3 \text{ V})$
- (5) Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- (6) Power-down protection provided on all inputs and outputs
- (7) Pin and function compatible with the 74 series (74LVC/ALVC/ etc.) 74 type

Note 1: This device is compliant with the reliability requirements of AEC-Q100. For details, contact your Toshiba sales representative.

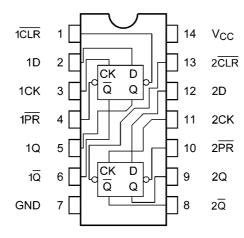
4. Packaging



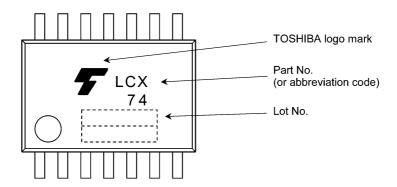
Start of commercial production



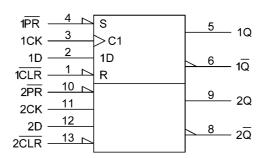
5. Pin Assignment



6. Marking



7. IEC Logic Symbol



8. Truth Table

| | Inputs | | | Outputs | | Function | |
|-----|--------|---|--------|---------|-----|-----------|--|
| CLR | PR | D | СК | Q | Ια | Function | |
| L | Н | Х | Х | L | Н | Clear | |
| Н | L | Х | Х | н | L | Preset | |
| L | L | Х | Х | Н | Н | _ | |
| Н | Н | L | | L | Н | _ | |
| Н | Н | Н | | Н | L | _ | |
| Н | Н | Х | \Box | Qn | Qr. | No change | |

X: Don't care



9. Absolute Maximum Ratings (Note)

| Characteristics | Symbol | Note | Rating | Unit |
|---------------------------------|-----------------------------------|----------|-------------------------------|------|
| Supply voltage | V _{CC} | | -0.5 to 6.5 | V |
| Input voltage | V _{IN} | | -0.5 to 6.5 | V |
| Output voltage | V _{OUT} | (Note 1) | -0.5 to 6.5 | V |
| | | (Note 2) | -0.5 to V _{CC} + 0.5 | |
| Input diode current | I _{IK} | | -50 | mA |
| Output diode current | I _{OK} | (Note 3) | ±50 | mA |
| Output current | I _{OUT} | | ±50 | mA |
| Power dissipation | P _D | (Note 4) | 180 | mW |
| V _{CC} /ground current | I _{CC} /I _{GND} | | ±100 | mA |
| Storage temperature | T _{stg} | | -65 to 150 | °C |

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: $V_{CC} = 0 V$

Note 2: High (H) or Low (L) state. IOUT absolute maximum rating must be observed.

Note 3: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$

Note 4: 180 mW in the range of T_a = -40 to 85 °C. From T_a = 85 to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

10. Operating Ranges (Note)

| Characteristics | Symbol | Note | Rating | Unit |
|---------------------------|----------------------------------|----------|----------------------|------|
| Supply voltage | V _{CC} | | 1.65 to 3.6 | V |
| | | (Note 1) | 1.5 to 3.6 | |
| Input voltage | V _{IN} | | 0 to 5.5 | V |
| Output voltage | V _{OUT} | (Note 2) | 0 to 5.5 | V |
| | | (Note 3) | 0 to V _{CC} | |
| Output current | I _{OH} ,I _{OL} | (Note 4) | ±24 | mA |
| | I _{OH} ,I _{OL} | (Note 5) | ±12 | |
| Operating temperature | T _{opr} | | -40 to 125 | °C |
| Input rise and fall times | dt/dv | (Note 6) | 0 to 10 | ns/V |

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either V_{CC} or GND.

Note 1: Data retention only.

Note 2: $V_{CC} = 0 V$

Note 3: High or low state Note 4: V_{CC} = 3.0 to 3.6 V

Note 5: V_{CC} = 2.7 to 3.0 V

Note 6: V_{IN} =0.8 to 2.0 V , V_{CC} = 3.0 V



11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

| Characteristics | Symbol | Test Condition | | V _{CC} (V) | Min | Max | Unit |
|---------------------------|------------------|--|---------------------------|---------------------|-----------------------|-----------------------|----------|
| High-level input voltage | V _{IH} | _ | | 1.65 to 2.3 | $V_{CC} \times 0.9$ | _ | V |
| | | | | 2.3 to 2.7 | 1.7 | _ | |
| | | | | 2.7 to 3.6 | 2.0 | _ | |
| Low-level input voltage | V _{IL} | _ | | 1.65 to 2.3 | _ | V _{CC} × 0.1 | V |
| | | | | 2.3 to 2.7 | _ | 0.7 | |
| | | | | 2.7 to 3.6 | _ | 0.8 | |
| High-level output voltage | V _{OH} | V _{IN} = V _{IH} or V _{IL} | I _{OH} = -100 μA | 1.65 to 3.6 | V _{CC} - 0.2 | _ | ٧ |
| | | | $I_{OH} = -4 \text{ mA}$ | 1.65 | 1.05 | _ | |
| | | | I_{OH} = -8 mA | 2.3 | 1.7 | _ | |
| | | | I _{OH} = -12 mA | 2.7 | 2.2 | _ | |
| | | | I _{OH} = -18 mA | 3.0 | 2.4 | _ | |
| | | | I _{OH} = -24 mA | 3.0 | 2.2 | _ | |
| Low-level output voltage | V _{OL} | V _{IN} = V _{IH} or V _{IL} | I _{OL} = 100 μA | 1.65 to 3.6 | _ | 0.2 | \ |
| | | | I _{OL} = 4 mA | 1.65 | _ | 0.45 | |
| | | | I_{OL} = 8 mA | 2.3 | _ | 0.7 | |
| | | | I _{OL} = 12 mA | 2.7 | _ | 0.4 | |
| | | | I _{OL} = 16 mA | 3.0 | _ | 0.4 | |
| | | | I _{OL} = 24 mA | 3.0 | _ | 0.55 | |
| Input leakage current | I _{IN} | V _{IN} = 0 to 5.5 V | | 1.65 to 3.6 | _ | ±5.0 | μΑ |
| Power-OFF leakage current | I _{OFF} | V _{IN} /V _{OUT} = 5.5 V | | 0 | _ | 10.0 | μΑ |
| Quiescent supply current | I _{CC} | $V_{IN} = V_{CC}$ or GND | | 1.65 to 3.6 | _ | 10.0 | μΑ |
| | I _{CC} | V _{IN} = 3.6 to 5.5 V | | 1.65 to 3.6 | _ | ±10.0 | |
| Quiescent supply current | Δl _{CC} | V _{IH} = V _{CC} - 0.6 V (per 1 input) | | 2.7 to 3.6 | _ | 500 | μА |



11.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C)

| Characteristics | Symbol | Test Condition | ı | V _{CC} (V) | Min | Max | Unit |
|---------------------------|------------------|--|--------------------------|---------------------|-----------------------|-----------------------|------|
| High-level input voltage | V _{IH} | _ | | 1.65 to 2.3 | $V_{CC} \times 0.9$ | _ | V |
| | | | | 2.3 to 2.7 | 1.7 | _ | |
| | | | | 2.7 to 3.6 | 2.0 | _ | |
| Low-level input voltage | V _{IL} | _ | | 1.65 to 2.3 | _ | V _{CC} × 0.1 | V |
| | | | | 2.3 to 2.7 | _ | 0.7 | |
| | | | | 2.7 to 3.6 | _ | 0.8 | |
| High-level output voltage | V _{OH} | $V_{IN} = V_{IH}$ or V_{IL} | I_{OH} = -100 μ A | 1.65 to 3.6 | V _{CC} - 0.2 | _ | V |
| | | | I_{OH} = -4 mA | 1.65 | 0.9 | _ | |
| | | | I_{OH} = -8 mA | 2.3 | 1.55 | _ | |
| | | | I_{OH} = -12 mA | 2.7 | 2.0 | _ | |
| | | | I_{OH} = -18 mA | 3.0 | 2.2 | _ | |
| | | | I _{OH} = -24 mA | 3.0 | 2.0 | _ | |
| Low-level output voltage | V _{OL} | $V_{IN} = V_{IH}$ or V_{IL} | I_{OL} = 100 μ A | 1.65 to 3.6 | _ | 0.2 | V |
| | | | I_{OL} = 4 mA | 1.65 | _ | 0.65 | |
| | | | I_{OL} = 8 mA | 2.3 | _ | 0.9 | |
| | | | I_{OL} = 12 mA | 2.7 | _ | 0.6 | |
| | | | I _{OL} = 16 mA | 3.0 | _ | 0.6 | |
| | | | I _{OL} = 24 mA | 3.0 | _ | 0.75 | |
| Input leakage current | I _{IN} | V _{IN} = 0 to 5.5 V | | 1.65 to 3.6 | _ | ±20.0 | μΑ |
| Power-OFF leakage current | I _{OFF} | V _{IN} /V _{OUT} = 5.5 V | | 0 | _ | 40.0 | μΑ |
| Quiescent supply current | I _{CC} | V _{IN} = V _{CC} or GND | | 1.65 to 3.6 | _ | 40.0 | μΑ |
| | I _{CC} | V _{IN} = 3.6 to 5.5 V | | 1.65 to 3.6 | _ | ±40.0 | |
| Quiescent supply current | Δl _{CC} | V _{IH} = V _{CC} - 0.6 V (per 1 input) | | 2.7 to 3.6 | _ | 5.0 | mA |



11.3. AC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

| Characteristics | Symbol | Note | Test Condition | V _{CC} (V) | Min | Max | Unit |
|---|--|---------------------------|---------------------------|---------------------|------|------|------|
| Maximum clock frequency | f _{MAX} | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 50 | _ | MHz |
| | | | Table 11.8.1, Fig. 11.8.1 | 2.5 ± 0.2 | 100 | _ | |
| | | | | 2.7 | 100 | _ | |
| | | | | 3.3 ± 0.3 | 150 | _ | |
| Propagation delay time | t _{PLH} ,t _{PHL} | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | _ | 22.0 | ns |
| $(CK-Q,\overline{Q})$ | | | Table 11.8.1, Fig. 11.8.1 | 2.5 ± 0.2 | _ | 9.0 | |
| | | | | 2.7 | _ | 8.0 | |
| | | | | 3.3 ± 0.3 | 1.5 | 7.0 | |
| Propagation delay time | t _{PLH} ,t _{PHL} | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | _ | 22.0 | ns |
| $(\overline{CLR},\overline{PR}-Q,\overline{Q})$ | | | Table 11.8.1, Fig. 11.8.3 | 2.5 ± 0.2 | _ | 9.0 | |
| | | | | 2.7 | _ | 8.0 | |
| | | | | 3.3 ± 0.3 | 1.5 | 7.0 | |
| Minimum pulse width | $t_{w(L)},t_{w(H)}$ | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 10.0 | _ | ns |
| (CK) | | Table 11.8.1, Fig. 11.8.1 | 2.5 ± 0.2 | 5.0 | _ | | |
| | | | | 2.7 | 3.3 | _ | |
| | | | | 3.3 ± 0.3 | 3.3 | _ | |
| Minimum pulse width | t _{w(L)} | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 10.0 | _ | ns |
| (CLR,PR) | (_/ | | Table 11.8.1, Fig. 11.8.3 | 2.5 ± 0.2 | 5.0 | _ | |
| | | | | 2.7 | 3.6 | _ | |
| | | | | 3.3 ± 0.3 | 3.3 | _ | |
| Minimum setup time | t _S | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 10.0 | _ | ns |
| · | | | Table 11.8.1, Fig. 11.8.1 | 2.5 ± 0.2 | 5.0 | _ | |
| | | | | 2.7 | 2.5 | _ | |
| | | | | 3.3 ± 0.3 | 2.5 | _ | |
| Minimum hold time | t _h | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 1.5 | _ | ns |
| | | | Table 11.8.1, Fig. 11.8.1 | 2.5 ± 0.2 | 1.5 | _ | |
| | | | | 2.7 | 1.5 | _ | |
| | | | | 3.3 ± 0.3 | 1.5 | _ | |
| Minimum removal time | t _{rem} | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 10.0 | _ | ns |
| | | | Table 11.8.1, Fig. 11.8.2 | 2.5 ± 0.2 | 5.0 | _ | |
| | | | | 2.7 | 3.0 | _ | |
| | | | | 3.3 ± 0.3 | 2.5 | _ | |
| Output skew | t _{osLH} ,t _{osHL} (| Note 1) | _ | 2.7 | _ | _ | ns |
| , | OSETT OSTIE | , , | | 3.3 ± 0.3 | _ | 1.0 | |

Note 1: Parameter guaranteed by design. $(t_{osLH} = |t_{PLH}m-t_{PLH}n|, t_{osHL} = |t_{PHL}m-t_{PHL}n|)$



11.4. AC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C)

| Characteristics | Symbol | Note | Test Condition | V _{CC} (V) | Min | Max | Unit |
|---|--|----------|---------------------------|---------------------|-------|------|------|
| Maximum clock frequency | f _{MAX} | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 45.0 | _ | MHz |
| | | | Table 11.8.1, Fig. 11.8.1 | 2.5 ± 0.2 | 90.0 | | |
| | | | | 2.7 | 90.0 | | |
| | | | | 3.3 ± 0.3 | 135.0 | _ | |
| Propagation delay time | t _{PLH} ,t _{PHL} | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | _ | 24.5 | ns |
| $(CK-Q,\overline{Q})$ | | | Table 11.8.1, Fig. 11.8.1 | 2.5 ± 0.2 | _ | 10.0 | |
| | | | | 2.7 | _ | 9.0 | |
| | | | | 3.3 ± 0.3 | 1.5 | 8.0 | |
| Propagation delay time | t _{PLH} ,t _{PHL} | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | _ | 24.5 | ns |
| $(\overline{CLR},\overline{PR}-Q,\overline{Q})$ | | | Table 11.8.1, Fig. 11.8.3 | 2.5 ± 0.2 | _ | 10.0 | |
| | | | | 2.7 | _ | 9.0 | |
| | | | | 3.3 ± 0.3 | 1.5 | 8.0 | |
| Minimum pulse width | $t_{w(L)}, t_{w(H)}$ | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 10.0 | _ | ns |
| (CK) | | | Table 11.8.1, Fig. 11.8.1 | 2.5 ± 0.2 | 5.0 | _ | |
| | | | | 2.7 | 3.3 | _ | |
| | | | | 3.3 ± 0.3 | 3.3 | _ | |
| Minimum pulse width | t _{w(L)} | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 10.0 | _ | ns |
| (CLR,PR) | | | Table 11.8.1, Fig. 11.8.3 | 2.5 ± 0.2 | 5.0 | _ | |
| | | | | 2.7 | 3.6 | _ | |
| | | | | 3.3 ± 0.3 | 3.3 | _ | |
| Minimum setup time | t _S | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 10.0 | _ | ns |
| | | | Table 11.8.1, Fig. 11.8.1 | 2.5 ± 0.2 | 5.0 | _ | |
| | | | | 2.7 | 2.5 | _ | |
| | | | | 3.3 ± 0.3 | 2.5 | _ | |
| Minimum hold time | t _h | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 1.5 | _ | ns |
| | | | Table 11.8.1, Fig. 11.8.1 | 2.5 ± 0.2 | 1.5 | _ | |
| | | | | 2.7 | 1.5 | _ | |
| | | | | 3.3 ± 0.3 | 1.5 | | |
| Minimum removal time | t _{rem} | | See 11.7 AC Test Circuit, | 1.8 ± 0.15 | 10.0 | _ | ns |
| | | | Table 11.8.1, Fig. 11.8.2 | 2.5 ± 0.2 | 5.0 | | |
| | | | | 2.7 | 3.0 | _ | |
| | | | | 3.3 ± 0.3 | 2.5 | _ | |
| Output skew | t _{osLH} ,t _{osHL} (| (Note 1) | _ | 2.7 | _ | _ | ns |
| • | OSELIA OSITE | , / | | 3.3 ± 0.3 | _ | 1.0 | |

Note 1: Parameter guaranteed by design. $(t_{osLH} = |t_{PLH}m-t_{PLH}n|, t_{osHL} = |t_{PHL}m-t_{PHL}n|)$



11.5. Dynamic Switching Characteristics (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 2.5 ns, C_L = 50 pF, R_L = 500 Ω)

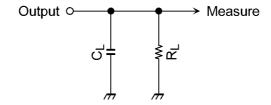
| Characteristics | Symbol | Test Condition | V _{CC} (V) | Тур. | Unit |
|--|------------------|--|---------------------|------|------|
| Quiet output maximum dynamic V _{OL} | V _{OLP} | V _{IH} = 3.3 V, V _{IL} = 0 V | 3.3 | 0.8 | V |
| Quiet output minimum dynamic V _{OL} | V _{OLV} | V _{IH} = 3.3 V, V _{IL} = 0 V | 3.3 | 0.8 | V |

11.6. Capacitive Characteristics (Unless otherwise specified, T_a = 25 °C)

| Characteristics | Symbol | Note | Test Condition | V _{CC} (V) | Тур. | Unit |
|-------------------------------|------------------|----------|--------------------------|---------------------|------|------|
| Input capacitance | C _{IN} | | _ | 3.3 | 7 | pF |
| Output capacitance | C _{OUT} | | _ | 0 | 8 | pF |
| Power dissipation capacitance | C _{PD} | (Note 1) | f _{IN} = 10 MHz | 3.3 | 25 | pF |

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation. $I_{CC}(opr) = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/2$ (per 1 bit)

11.7. AC Test Circuit





11.8. AC Waveform

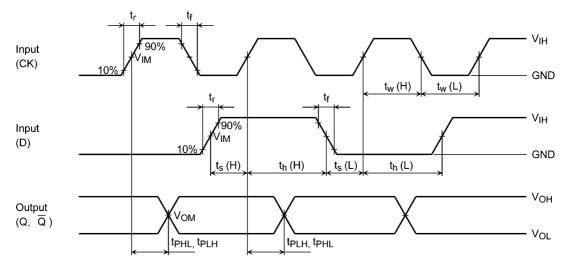


Fig. 11.8.1 t_{PLH} , t_{PHL} , t_w , t_s , t_h

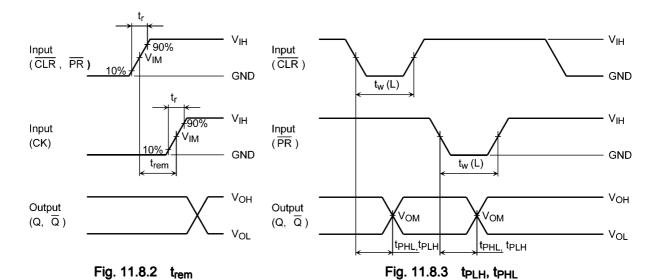


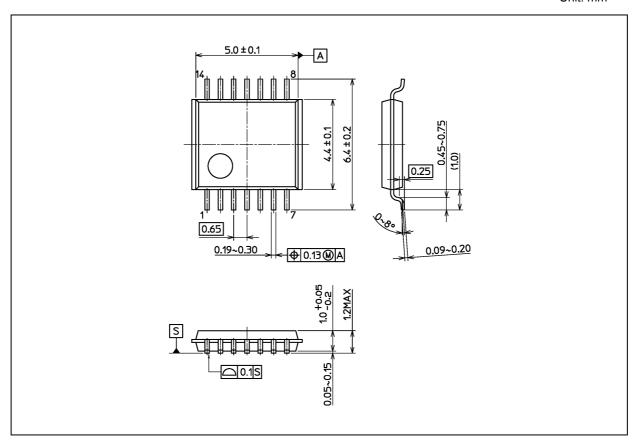
Table 11.8.1 AC Waveform Symbols

| | Symbol | $V_{CC} = 3.3 \pm 0.3 \text{ V}$ $V_{CC} = 2.7 \text{ V}$ | V_{CC} = 2.5 ± 0.2 V | V _{CC} = 1.8 ± 0.15 V |
|--------|---------------------------------|--|------------------------|--------------------------------|
| Input | V _{IH} | 2.7 V | V _{CC} | V _{CC} |
| | V _{IM} | 1.5 V | V _{CC} /2 | V _{CC} /2 |
| | t _r , t _f | 2.5 ns | 2.0 ns | 2.0 ns |
| Output | V _{OM} | 1.5 V | V _{OH} /2 | V _{OH} /2 |
| Load | C _L | 50 pF | 30 pF | 30 pF |
| | R_L | 500 Ω | 500 Ω | 1 kΩ |



Package Dimensions

Unit: mm



Weight: 0.054 g (typ.)

| | Package Name(s) |
|--------------------|-----------------|
| Nickname: TSSOP14B | |



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